LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

Winstar Display Co., LTD 華凌光電股份有限公司

CUSTOMER

(FOR CUSTOMER USE ONLY)



DATA:

WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

-	
MODULE NO.:	WG240128A-TFH-VZ#
APPROVED BY:	

PCB VERSION:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
M	2018/08/20		Modify PCB.



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2007/01/16		First issue
A	2008/02/21		Modify pin4=Vo,pin9=Vee
В	2008/11/25		Modify backlight
			information.
С	2009/09/04		Modify View area
D	2010/02/02		Modify RA6963 IC
Е	2013/05/29	\C	Remove IC information
			Modify B/L information
F	2014/06/24		Correct Contour Drawing.
G	2014/12/10		Modify length of cable.
Н	2016/01/27		Modify Precautions in use
	(C)		of LCD Modules
			& Static electricity test
I	2016/11/25		Modify IDD
J	2017/02/28		Modify Backlight
			Information
K	2017/03/01		Modify VIL
L	2018/06/04		Modify contour drawing
M	2018/08/20		Modify PCB.

Contents

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
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- 10.Backlight Information
- 11.Inspection specification
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1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 240 * 128 dot

Model serials no.

 $B \rightarrow EL$, Blue green $A \rightarrow LED$, Amber $L \rightarrow LED$, Full color $D \rightarrow EL$, Green $R \rightarrow LED$, Red $J \rightarrow DIP LED$, Blue $W \rightarrow EL$, White $O \rightarrow LED$, Orange $K \rightarrow DIP LED$, White

 $M\rightarrow EL$, Yellow Green $G\rightarrow LED$, Green $E\rightarrow DIP$ LED, Yellow Green

F \rightarrow CCFL, White P \rightarrow LED, Blue H \rightarrow DIP LED, Amber Y \rightarrow LED, Yellow Green X \rightarrow LED, Dual color I \rightarrow DIP LED, Red

 $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Built in negative voltage

Z:IC NT7086

#:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.

3.General Specification

Item	Dimension	Unit
Number of dots	240 x 128	_
Module dimension	170.0 x 93.4 x 12.4(MAX)	mm
View area	128.0 x 74.0	mm
Active area	119.97 x 63.97	mm
Dot size	0.47 x 0.47	mm
Dot pitch	0.50 x 0.50	mm
LCD type	FSTN Positive Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same based on the same based of the same based of the same based on the	
Duty	1/128	
View direction	6 o'clock	
Backlight Type	LED White	
IC	RA6963	

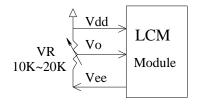
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}$
Storage Temperature	Tst	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V _{IN}	-0.3	_	V _{DD} +0.3	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	-0.3	_	+7.0	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	3.0	_	5.5	V
		Ta=-20°C	_	_	20.1	V
Supply Voltage For LCD	V_{DD} - V_{0}	Ta=25°℃	17.5	18.0	18.5	V
*Note		Ta=70°C	16.3	_	4- 1	v
Input High Volt.	$V_{ m IH}$	_	0.8V _{DD}	_	V_{DD}	V
Input Low Volt.	$V_{\rm IL}$	_	0	^− C	$0.15~V_{DD}$	V
Output High Volt.	V_{OH}	_	V _{DD} -0.3		V_{DD}	V
Output Low Volt.	V_{OL}	-	0	_	0.3	V
Supply Current	I_{DD}	~	15	30	60	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

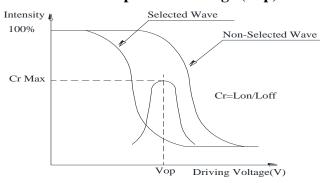


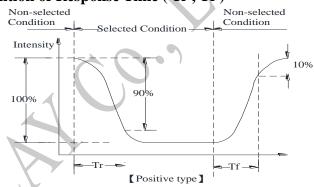
6.Optical Characteristics

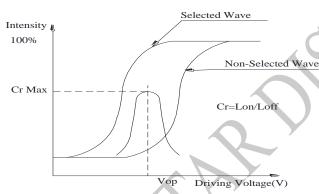
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
View Angle	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	—	250	350	ms

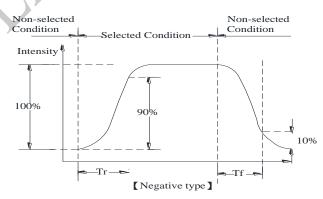
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)









Conditions:

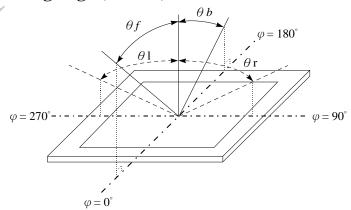
Operating Voltage: Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ

Driving Waveform: 1/N duty, 1/a bias

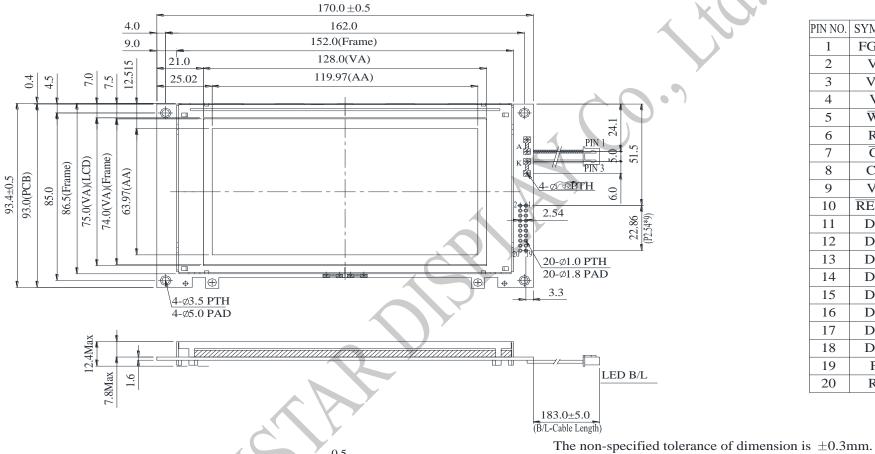
Definition of viewing angle($CR \ge 2$)



7.Interface Pin Function

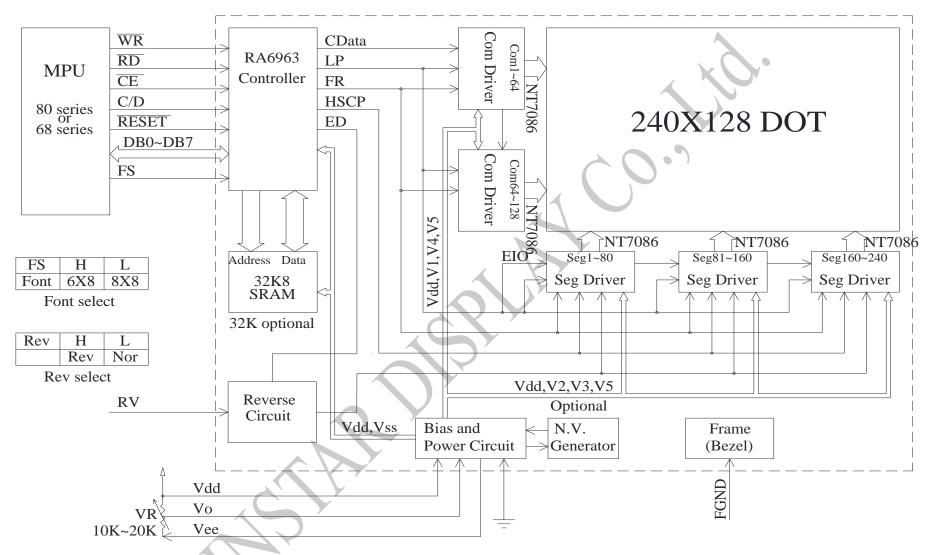
Pin No.	Symbol	Level	Description			
1	FGND	-	Frame ground (Connected to bezel)			
2	Vss	-	GND			
3	Vdd	-	Power supply			
4	Vo	-	Power supply for LCD driver			
5	WR	L	Data write. Write data into RA6963when WR = L			
6	RD	L	Data read. Read data from RA6963when RD = L			
7	CE	L	L : Chip enable			
8	C/D	H/L	WR=L, C/D=H: Command Write C/D=L: Data write			
			RD=L, C/D=H: Status Read C/D=L: Data read			
9	Vee	I	Negative Voltage Output			
10	RESET	H/L	H: Normal; L: Initialize RA6963			
11	DB0	H/L	Data bus line			
12	DB1	H/L	Data bus line			
13	DB2	H/L	Data bus line			
14	DB3	H/L	Data bus line			
15	DB4	H/L	Data bus line			
16	DB5	H/L	Data bus line			
17	DB6	H/L	Data bus line			
18	DB7	H/L	Data bus line			
19	FS	MD2	Pins for selection of font; H: 6 * 8, L: 8 * 8			
20	RV	H/L	H: Reverse L: Normal			

8.Contour Drawing & Block Diagram



PIN NO.	SYMBOL
1	FGND
2	Vss
3	Vdd
4	Vo
5	$\overline{\mathrm{WR}}$
6	RD
7	CE
8	C/D
9	Vee
10	RESET
11	DB0
12	DB1
13	DB2
14	DB3
15	DB4
16	DB5
17	DB6
18	DB7
19	FS
20	RV

DOT SIZE SCALE 10/1



External contrast adjustment.

9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test						
Test Item	Content of Test	Test Condition	Not e			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs ▲	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1			
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles				
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= ± 600 V(contact), ± 800 v(air), RS= 330Ω CS= 150 pF 10 times				

Note1: No dew condensation to be observed.

Note 2: The function test shall be conducted after 4 hours storage at the normal ${\bf r}$

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

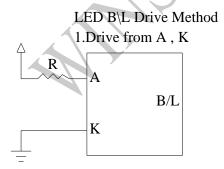
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	96	128	160	mA	V=3.5V(Note 1)
Supply Voltage	V	3.4	3.5	3.6	V	- k 0
Reverse Voltage	VR		_	5	V	-
Luminance (Without LCD)	IV	729	912	_	CD/M ²	ILED=128mA
LED Life Time (For Reference only)	_	_	50K	- 1	Hr.	HLED≤128 mA 25°C,50-60%RH, (Note 2)
Color	White	1		YY		,

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.



11.Inspection specification

NO	Item	Criterion				AQL		
		Missing vertical	, horizonta	al segment, segmen	nt contrast defect.			
		Missing character, dot or icon.						
		Display malfunction.						
01	Electrical	No function or r	No function or no display.					
01	Testing	Current consum	ption exce	eds product specif	fications.	0.65		
		LCD viewing ar	ngle defect	•	V ()			
		Mixed product t	ypes.			,		
		Contrast defect.						
	Black or	2.1 White and h	lack enote	on display < 0.25	mm, no more than			
02	white spots on	three white or bl	_		min, no more than	2.5		
02	LCD (display		•	•	or lines within 3mm	2.3		
	only)	2.2 Delisery spar	cca. 140 m	ore than two spots	of thics within 5him			
		3.1 Round type	: As follow	ving drawing				
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY			
				Ф≦0.10	Accept no dense			
				$0.10 < \Phi \le 0.20$	2			
		4		$0.20 < \Phi \le 0.25$	1	2.5		
				0.25<Φ	0	2.3		
	LCD black	X	•					
	spots, white	→ 1_1	<u>↓</u>					
03	spots, winte	• .	X Y					
03	contamination		Ī					
	(non-display)	3.2 Line type : (As follow	ing drawing)				
	(non display)		Length	Width	Acceptable Q TY			
		_ /¥ w		W≤0.02	Accept no dense			
Á		→	L≦3.0	$0.02 < W \le 0.03$		2.5		
	\ \	1.	L≦2.5	$0.03 < W \le 0.05$		2.3		
				0.05 < W	As round type			
				1	· · · · · · · · ·			

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
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NO	Item	Criterion A			AQL
05	Scratches	Follow NO.3 LCD blac	ck spots, white spots, co	ntamination	
		Symbols Define:			
		x: Chip length y	: Chip width z: Ch	ip thickness	
		k: Seal width t:	Glass thickness a: LC	CD side length	
		L: Electrode pad length	1:		
		6.1 General glass chip:			
		6.1.1 Chip on panel sur	face and crack between	panels:	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5
	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	2.5
		⊙ If there are 2 or more 6.1.2 Corner crack:	e chips, x is total length	of each chip.	
			CIL: LII		
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	$x \le 1/8a$	
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more	e chips, x is the total len	gth of each chip.	

NO	Item	Criterion			AQL
		Symbols:			
		x: Chip length y: Chip width	z: Chip thi	ckness	
		k: Seal width t: Glass thickness	-		
		L: Electrode pad length		•	
		6.2 Protrusion over terminal:			
		6.2.1 Chip on electrode pad :			
06	Glass	$\begin{array}{ c c c c c }\hline y: Chip \ width & x: Chip \ lengt \\\hline y \leq 0.5mm & x \leq 1/8a \\\hline 6.2.2 \ Non-conductive \ portion: \\\hline \\ & X \\\hline \end{array}$		$ \begin{array}{c c} \text{Chip thickness} \\ \hline z \leqq t \\ \hline \\ Z \\ \hline \\ X \end{array} $	2.5
		y: Chip width x: Chip le	angth 7:	Chip thickness	
		$y \le L \qquad x \le 1/8a$		$< z \le t$	
		⊙ If the chipped area touches the ITO			
	_	remain and be inspected according to Olf the product will be heat sealed by		-	
		be damaged.	the editorner,	the ungilinent mark not	
4		6.2.3 Substrate protuberance and inter	nal crack.		
		y: wi		x: length	
		$y \le 1$		$x \leq a$	
				·- = "	
		3.33			

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
elements		Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production	0.65
10	TCD COD	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
	16	X	
	7	$X * Y \le 2mm^2$	
4		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
	Pin (OLB) of TCP.	Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.

Connector soldering wave or hand soldering: 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



winstar <u>LCM Samp</u> Todule Number:		Feedback Sheet Page: 1
1 · Panel Specification :		Tuge. I
1. Panel Type:	Pass	□ NG,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	☐ Pass	□ NG ,
4. View Area:	☐ Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature:	Pass	□ NG ,
7. Storage Temperature:	Pass	□ NG ,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	☐ Pass	\square NG,
2. Frame Size:	Pass	□ NG,
3. Materal of Frame:	☐ Pass	□ NG,
4. Connector Position:	Pass	□ NG,
5. Fix Hole Position:	Pass	□ NG,
6. Backlight Position:	☐ Pass	□ NG,
7. Thickness of PCB:	☐ Pass	□ NG ,
8. Height of Frame to PCB:	☐ Pass	□ NG ,
9. Height of Module:	Pass	□ NG ,
10. Others:	☐ Pass	□ NG,
3 · Relative Hole Size:		
1. Pitch of Connector:	☐ Pass	□ NG ,
2. Hole size of Connector:	☐ Pass	□ NG ,
3. Mounting Hole size:	Pass	□ NG ,
4. Mounting Hole Type:	Pass	□ NG ,
5. Others:	Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	Pass	☐ NG ,
2. B/L Color:	Pass	☐ NG ,
3. B/L Driving Voltage (Refere	ence for LED	
4. B/L Driving Current:	Pass	\square NG ,
5. Brightness of B/L:	☐ Pass	□ NG ,
6. B/L Solder Method:	☐ Pass	□ NG ,
7. Others:	☐ Pass	□ NG ,
	>> Go to	page 2 <<

winstar [odule Number :		Page: 2
5 · Electronic Characteristics of	Module:	
1. Input Voltage:	Pass	□ NG ,
2. Supply Current:	Pass	□ NG ,
3. Driving Voltage for LCD:	Pass	□ NG ,
4. Contrast for LCD:	Pass	□ NG ,
5. B/L Driving Method:	Pass	□ NG ,
6. Negative Voltage Output:	Pass	□ NG ,
7. Interface Function:	Pass	□ NG ,
8. LCD Uniformity:	Pass	□ NG ,
9. ESD test:	Pass	□ NG ,
10. Others:	Pass	□ NG ,
6 · Summary :		
Sales signature :		
Customer Signature :		